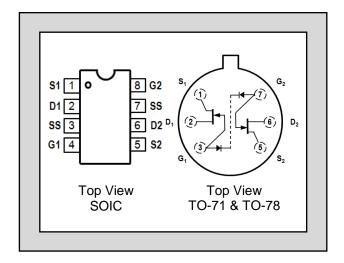


Twenty-Five Years Of Quality Through Innovation

LS830 LS831 LS832 LS833

ULTRA LOW LEAKAGE LOW DRIFT MONOLITHIC DUAL N-CHANNEL JFET AMPLIFIER

| FEATURES | | | | | | | | |
|--|-----------------------|-------------------------------|-------------------|--|--|--|--|--|
| ULTRA LO | OW DRIFT | ΔV _{GS1-2} /Δ | T = 5μV/°C max. | | | | | |
| ULTRA LO | DW NOISE | I _G =80fA TY | A TYP. | | | | | |
| LOW NOIS | SE | e _n =70nV/√Hz TYP. | | | | | | |
| LOW CAP | ACITANCE | C _{ISS} =3pf max. | | | | | | |
| ABSOLUTE MAXIMUM RATINGS NOTE 1 | | | | | | | | |
| @ 25°C (unless otherwise noted) | | | | | | | | |
| Maximum Temperatures | | | | | | | | |
| Storage T | -55 to +150°C | | | | | | | |
| Operating | -55 to +150°C | | | | | | | |
| Maximum Voltage and Current for Each Transistor NOTE 1 | | | | | | | | |
| -V _{GSS} | Gate Voltage to Drain | 40V | | | | | | |
| -V _{DSO} | Drain to Source Volta | 40V | | | | | | |
| -I _{G(f)} | Gate Forward Curren | 10mA | | | | | | |
| -l _G | Gate Reverse Curren | 10μΑ | | | | | | |
| Maximum Power Dissipation @ TA = 25°C | | | | | | | | |
| Continuo | 500mW | | | | | | | |

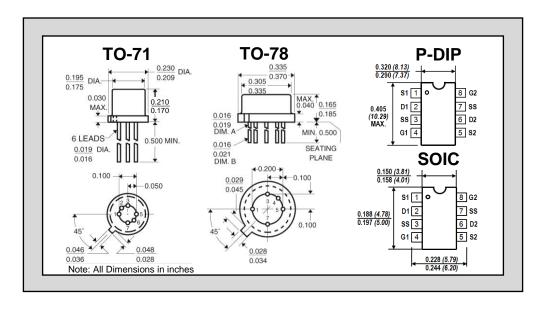


| SYMBOL | CHARACTERISTIC | MIN. | TYP. | MAX. | UNITS | CONDITIONS | | |
|-------------------|---------------------------------|------|------|------|-------|-----------------------|-----------------------|----------|
| BV _{GSS} | Breakdown Voltage | -40 | -60 | | V | V _{DS} = 0 | I _G = -1nA | |
| BV _{GGO} | Gate-to-Gate Breakdown | ±40 | | | V | I _G = ±1μΑ | $I_D=0$ | Is = 0 |
| | TRANSCONDUCTANCE | | | | | | | |
| G fss | Full Conduction | 70 | 300 | 500 | μS | V _{DG} = 10V | V _{GS} = 0 | f = 1kHz |
| g fs | Typical Operation | 50 | 100 | 200 | μS | V _{DG} = 10V | I _D = 30µA | f = 1kHz |
| gfs1-2/gfs | Differential | | 1 | 5 | % | | | |
| | DRAIN CURRENT | | | | | | | |
| I _{DSS} | Full Conduction | 60 | 400 | 1000 | μΑ | | | |
| IDSS1-2/IDSS | Differential at Full Conduction | | 2 | 5 | % | V _{DG} = 10V | V _{GS} = 0 | |

ELECTRICAL CHARACTERISTICS TA = 25°C (unless otherwise noted)

| SYMBOL | CHARACTERISTIC | LS830 | LS831 | LS832 | LS833 | UNITS | CONDITIONS | |
|------------------------------------|-----------------------|-------|-------|-------|-------|-------|---|-----------------------|
| $ \Delta V_{GS1-2}/\Delta T $ max. | Drift vs. Temperature | 5 | 10 | 20 | 75 | μV/ºC | $V_{DG} = 10V$ | I _D = 30µA |
| | | | | | | | $T_A = -55^{\circ}C$ to $+125^{\circ}C$ | |
| V _{GS1-2} max. | Offset Voltage | 25 | 25 | 25 | 25 | mV | $V_{DG} = 10V$ | $I_D = 30\mu A$ |
| -I _G typical | Operating | 0.1 | 0.1 | 0.1 | 0.5 | pА | | |
| -I _G typical | High Temperature | 0.1 | 0.1 | 0.1 | 0.5 | nA | TA= +125°C | |
| I _{GSS} typical | At Full Conduction | 0.2 | 0.2 | 0.2 | 1.0 | pА | V _{GS} = 20V, V _{GS} = 0V | |
| I _{GSS} typical | High Temperature | 0.5 | 0.5 | 0.5 | 1.0 | nA | $V_{GS} = 0$ | V _{GS} = 20V |
| | | | | | | | TA= +125°C | |

| SYMBOL | CHARACTERISTIC | MIN. | TYP. | MAX. | UNITS | CONDITIONS | | |
|-----------------------|--|------|------|------|--------|---|-----------------------|----------------------|
| | GATE-SOURCE | | | | | | | |
| V _{GS} (off) | Cutoff Voltage | -0.6 | -2 | -4.5 | V | $V_{DS} = 10V$ | $I_D=1nA$ | |
| V _G S | Operating Range | | | -4 | V | V _{DG} = 10V | I _D = 30μA | |
| | GATE CURRENT | | | | | | | |
| Iggo | Gate-to-Gate Leakage | | 1 | | pА | $V_{GG} = \pm 20V$ | $I_D = I_S = 0A$ | |
| | OUTPUT CONDUCTANCE | | | | | | | |
| goss | Full Conduction | | | 5 | μS | V_{DG} = 10 V | $V_{GS} = 0$ | |
| gos | Operating | | | 0.5 | μS | V _{DG} = 10V | I _D = 30μA | |
| g os 1-2 | Differential | | | 0.1 | μS | | | |
| | COMMON MODE REJECTION | | | | | | | |
| CMRR | -20 log ΔV _{GS1-2} / ΔV _{DS} | | 90 | | dB | ΔV_{DS} = 10 to 20V I _D =30µ | | I _D =30μA |
| CMRR | -20 log ΔV _{GS1-2} / ΔV _{DS} | | 90 | | dB | $\Delta V_{DS} = 5 \text{ to } 10V$ | | I _D =30μA |
| | <u>NOISE</u> | | | | | | | |
| NF | Figure | | | 1 | dB | $V_{DS} = 10V$ | $V_{GS} = 0$ | R_G =10 $M\Omega$ |
| | | | | | | f= 100Hz | NBW= 6Hz | |
| e _n | Voltage | | 20 | 70 | nV/√Hz | V _{DG} = 10V | I _D = 30μA | f= 10Hz |
| | | | | | | NBW= 1Hz | | |
| | <u>CAPACITANCE</u> | | | | | | | |
| C _{ISS} | Input | | | 3 | pF | $V_{DS} = 10V$ | $V_{GS}=0$ | f= 1MHz |
| Crss | Reverse Transfer | | | 1.5 | pF | V _{DS} = 10V | V _{GS} = 0 | f= 1MHz |
| C_DD | Drain-to-Drain | | | 0.1 | pF | V _{DG} = 10V | I _D = 30μA | |



NOTES:

1. These ratings are limiting values above which the serviceability of any semiconductor may be impaired

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